

Preface

The aim of the 7th International Conference on Advanced Materials and Engineering Materials (ICAMEM2018, Bangkok, Thailand 17-18 May 2018) was to provide leading academics and industry scientists a platform to communicate recent advances in Advanced Materials Science, Engineering Materials Research and an opportunity to establish multilateral collaborations.

Since the first ICAMEM in Shenyang, China (2011), a series of ICAMEM has been held in Asia: the 2nd, Beijing and Shanghai, China (2012); the 3rd, Singapore (2013); the 4th, Ningbo and Hong Kong, China (2014); the 5th, Hong Kong (2016) and the 6th, Singapore.

The papers were selected after the peer-review process by conference committee members and international reviewers. The submitted papers were selected on the basis of originality, significance, and clarity for the purpose of the conference.

On behalf of the organizing committee, the editor would like to acknowledge the technical comments from the reviewers and thank all of the authors for their contributions to this proceeding book.

With our warmest regards,

Conference Organizing Chair
Prof. Peng-Sheng Wei
National Sun Yat-Sen University, Kaohsiung, Taiwan
June 4, 2018

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